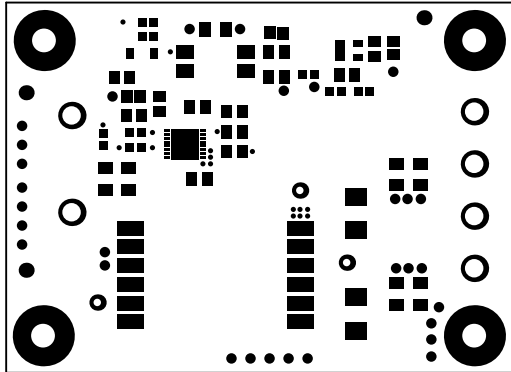
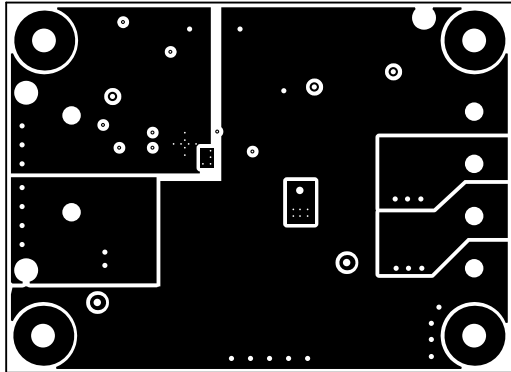


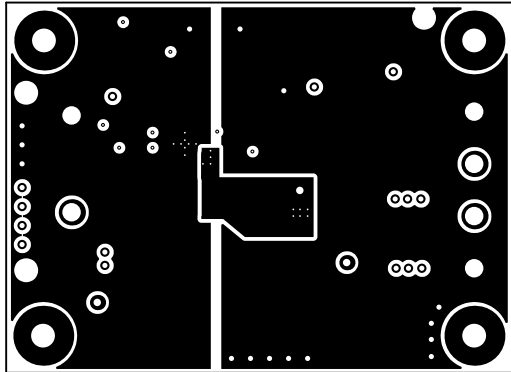
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP7932	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay			
PLOT NAME = Top Overlay	GENERATED : 1/20/2015 12:51:48 PM	TEXAS INSTRUMENTS	



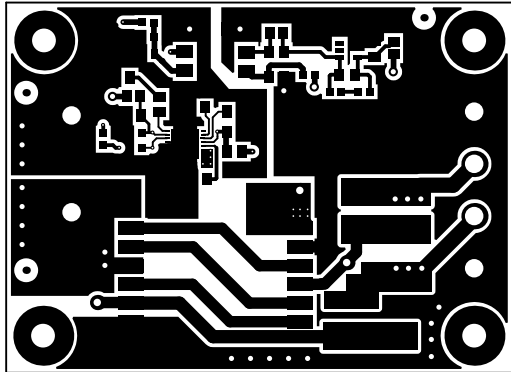
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP7932	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Solder			
PLOT NAME = Top Solder Mask	GENERATED : 1/20/2015 12:51:48 PM	TEXAS INSTRUMENTS	



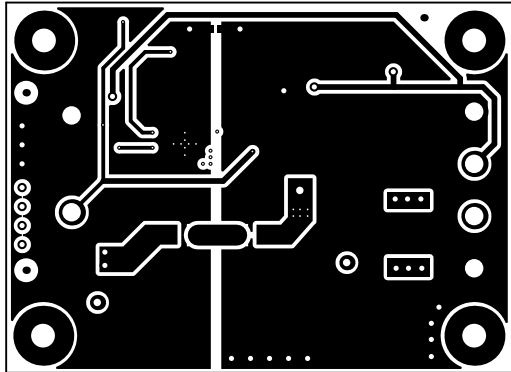
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP7932	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = M1 Board Outline			
PLOT NAME = Midlayer2	GENERATED : 1/20/2015 12:51:49 PM	TEXAS INSTRUMENTS	



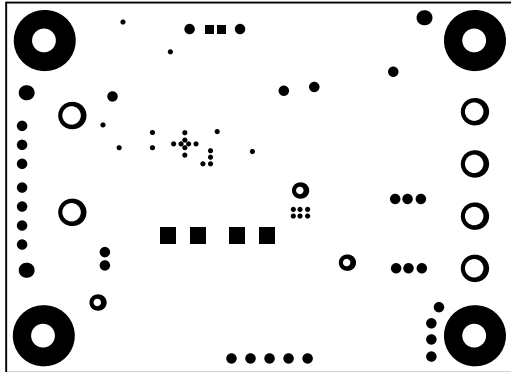
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP7932	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = M1 Board Outline			
PLOT NAME = Midlayer1	GENERATED : 1/20/2015 12:51:50 PM	TEXAS INSTRUMENTS	



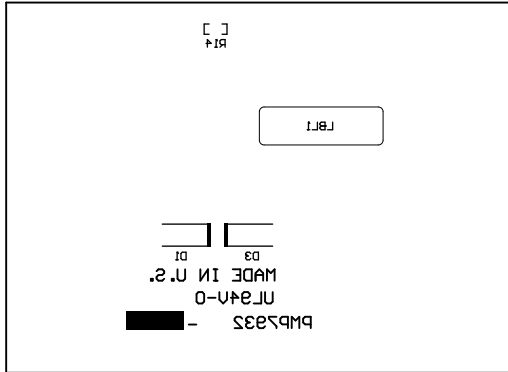
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP7932	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Layer			
PLOT NAME = Top Layer	GENERATED : 1/20/2015 12:51:50 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP7932	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer			
PLOT NAME = Bottom Layer	GENERATED : 1/20/2015 12:51:51 PM	TEXAS INSTRUMENTS	

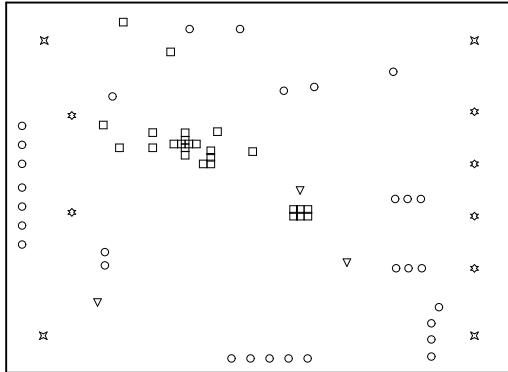


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP7932	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder			
PLOT NAME = Bottom Solder Mask	GENERATED : 1/20/2015 12:51:51 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP7932	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay			
PLOT NAME = Bottom Overlay	GENERATED : 1/20/2015 12:51:52 PM	TEXAS INSTRUMENTS	

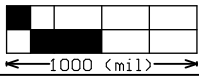
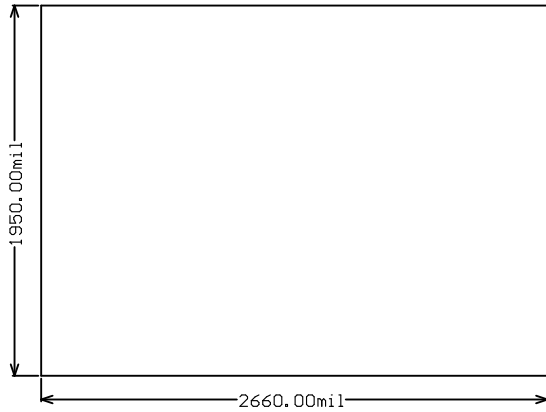




Symbol	Hit Count	Tool Size	Plated	Hole Type
□	26	10mil (0.254mm)	PTH	Round
○	30	28mil (0.711mm)	PTH	Round
▽	3	40mil (1.016mm)	PTH	Round
*	6	98.425mil (2.5mm)	PTH	Round
✕	4	125.984mil (3.2mm)	PTH	Round
	<b>69 Total</b>			

Drill Table

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP7932	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing			
PLOT NAME = Drill Drawing	GENERATED : 1/20/2015 12:51:53 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP7932	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions			
PLOT NAME = Board Dimensions	GENERATED : 1/20/2015 12:51:53 PM	TEXAS INSTRUMENTS	

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